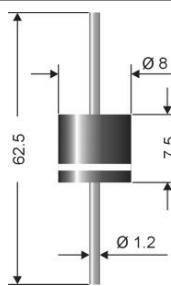


HE12FA...HE12FD



Axial lead diode

High efficiency fast silicon rectifier diode

HE12FA...HE12FD

Forward Current: 12 A

Reverse Voltage: 50 to 200 V

Features

- Max. solder temperature: 260°C
- Plastic material has UL classification 94V-0

Mechanical Data

- Plastic case 8 x 7,5 [mm]
- Weight approx.: 1,5 g
- Terminals: plated terminals solderable per MIL-STD-750
- Mounting position: any
- Standard packaging: 500 pieces per ammo

1) Valid, if leads are kept at ambient temperature at a distance of 10 mm from case

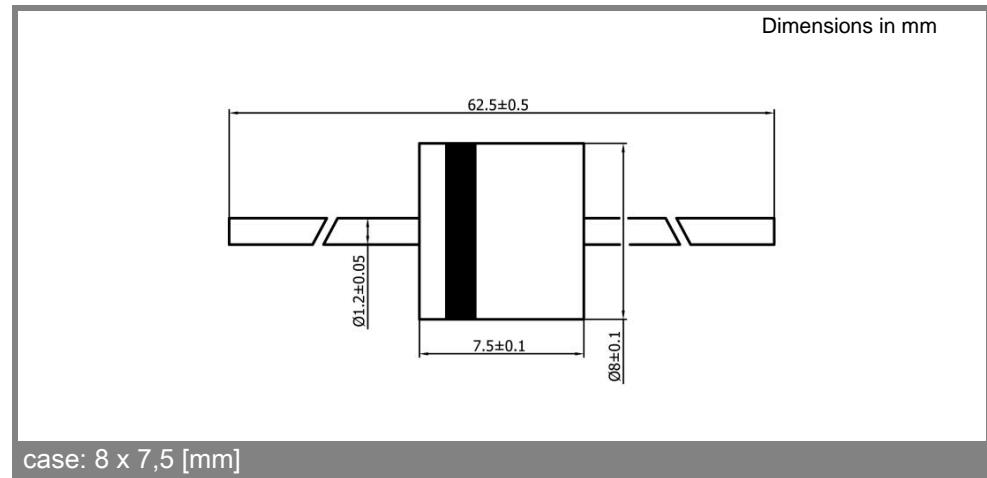
2) $I_F = 5 \text{ A}$, $T_j = 25^\circ\text{C}$

3) $T_A = 25^\circ\text{C}$

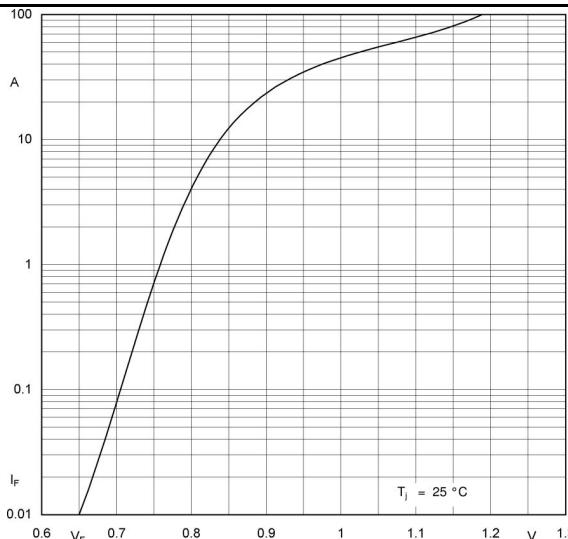
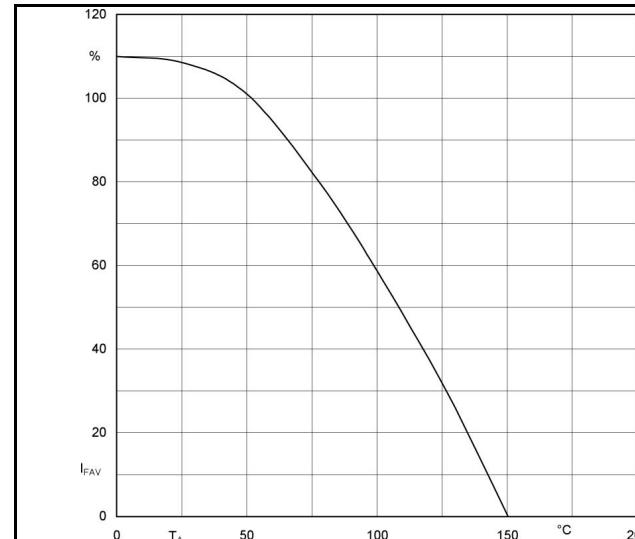
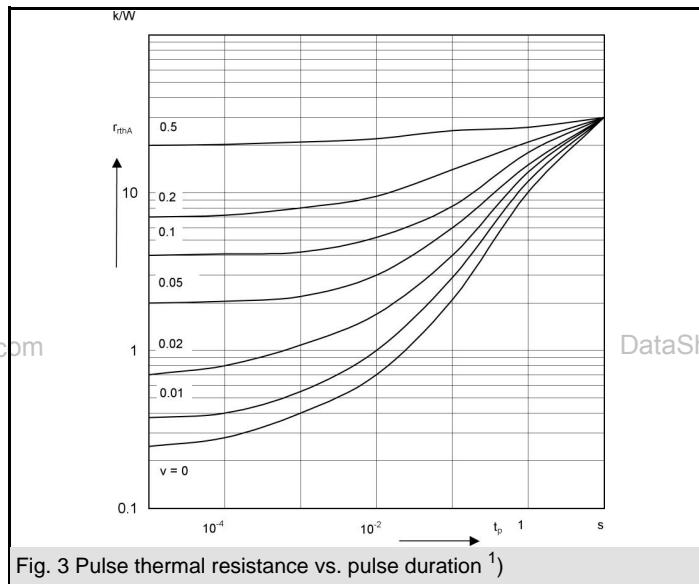
Type	Repetitive peak reverse voltage V_{RRM} V	Surge peak reverse voltage V_{RSM} V	Max. reverse recovery time t_{rr} ns	Max. forward voltage $V_F^{(2)}$
HE12FA	50	50	200	0,82
HE12FB	100	100	200	0,82
HE12FD	200	200	200	0,82

Absolute Maximum Ratings		$T_c = 25^\circ\text{C}$, unless otherwise specified	
Symbol	Conditions	Values	Units
I_{FAV}	Max. averaged fwd. current, R-load, $T_A = 50^\circ\text{C}$ ¹⁾	12	A
I_{FRM}	Repetitive peak forward current $f > 15 \text{ Hz}^1)$	80	A
I_{FSM}	Peak forward surge current 50 Hz half sinus-wave ³⁾	375	A
i^2t	Rating for fusing, $t < 10 \text{ ms}^3)$	680	A ² s
R_{thA}	Max. thermal resistance junction to ambient ¹⁾	12	K/W
R_{thT}	Max. thermal resistance junction to terminals ¹⁾	-	K/W
T_j	Operating junction temperature	-50...+150	°C
T_s	Storage temperature	-50...+175	°C

Characteristics		$T_c = 25^\circ\text{C}$, unless otherwise specified	
Symbol	Conditions	Values	Units
I_R	Maximum leakage current, $T_j = 25^\circ\text{C}$; $V_R = V_{RRM}$	<25	µA
	$T_j = {}^\circ\text{C}$; $V_R = V_{RRM}$		
C_J	Typical junction capacitance (at MHz and applied reverse voltage of V)	-	pF
Q_{rr}	Reverse recovery charge ($U_R = V$; $I_F = A$; $dI_F/dt = A/\text{ms}$)	-	µC
E_{RSM}	Non repetitive peak reverse avalanche energy ($I_R = mA$; $T_j = {}^\circ\text{C}$; inductive load switched off)	-	mJ



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Fig. 1 Forward characteristic (typical values) ¹⁾Fig. 2 Rated forward current vs. ambient temperature ¹⁾Fig. 3 Pulse thermal resistance vs. pulse duration ¹⁾

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